V30K202

Vishay General Semiconductor

High Current Density Surface-Mount (TMBS[®]) Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.53$ V at $I_F = 5$ A



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1, 2, 3, 4 • 5, 6, 7, 8

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	30 A				
V _{RRM}	200 V				
I _{FSM}	240 A				
V _F at I _F = 30 A (T _J = 125 °C)	0.72 V				
T _J max.	165 °C				
Package	FlatPAK 5 x 6				
Circuit configuration	Single				

FEATURES

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



AUTOMOTIV

Available

- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: FlatPAK 5 x 6 Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified (" X" denotes revision code e.g. A. B.

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Terminals: matter tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V30K202	UNIT	
Device marking code		V3022		
Maximum repetitive peak reverse voltage	V _{RRM}	200	V	
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	30		
Maximum DC forward current	I _{F(AV)} ⁽²⁾	3.4	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	240		
Operating junction temperature range	T _J ⁽³⁾	-40 to +165	0°	
Storage temperature range	T _{STG}	-55 to +165		

Notes

⁽¹⁾ With infinite heatsink

⁽²⁾ Free air, mounted on recommended pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0JA}

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ELECTRICAL CHARACTEI	RISTICS ($T_J =$	25 °C unless	otherwise not	ted)		
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
	I _F = 5 A	T _J = 25 °C	- V _F ⁽¹⁾	0.68	-	v
	I _F = 15 A			0.79	-	
	I _F = 30 A			0.87	1.04	
Instantaneous forward voltage	I _F = 5 A			0.53	-	
	I _F = 15 A T _J = 125 °C		0.63	-		
	I _F = 30 A			0.72	0.79	
	V _B = 160 V	T _J = 25 °C		0.001	-	
Reverse current	$v_{\rm R} = 100 v$	T _J = 125 °C	I _B ⁽²⁾	2	-	mA
neverse current	$V_{\rm R} = 200 \text{V}$ $T_{\rm J} = 25 ^{\circ}\text{C}$ -	-	0.15	ША		
	$v_{\rm R} = 200 V$	T _J = 125 °C		5	15	
Typical junction capacitance	4.0 V, 1 MHz		CJ	1250	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless oth	nerwise noted)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Thermal resistance	R _{0JA} (1)(2)	75	-	°C/W	
	R _{θJM} ⁽³⁾	2.5	3.5	C/W	

Notes

⁽¹⁾ The heat generated must be less than thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient

 $^{(3)}$ Mounted on infinite heatsink; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFO	RDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V30K202-M3/H	0.10	н	1500	7" diameter plastic tape and reel	
V30K202-M3/I	0.10	I	6000	13" diameter plastic tape and reel	
V30K202HM3_A/H (1)	0.10	Н	1500	7" diameter plastic tape and reel	
V30K202HM3_A/I (1)	0.10	I	6000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

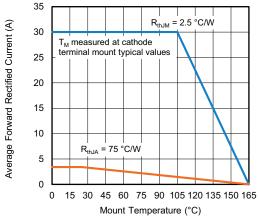


Fig. 1 - Maximum Forward Current Derating Curve

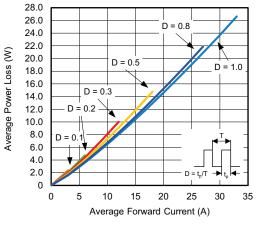


Fig. 2 - Forward Power Loss Characteristics

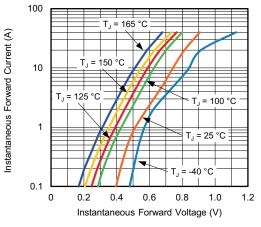


Fig. 3 - Typical Instantaneous Forward Characteristics

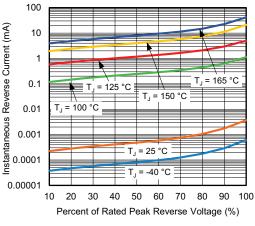


Fig. 4 - Typical Reverse Leakage Characteristics

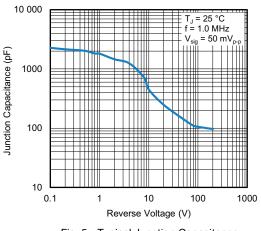


Fig. 5 - Typical Junction Capacitance

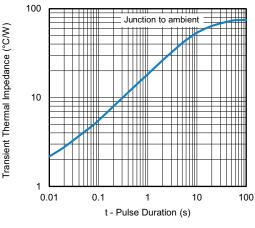


Fig. 6 - Typical Transient Thermal Impedance

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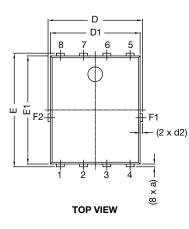
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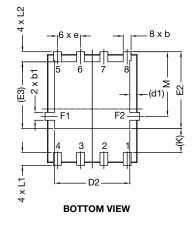


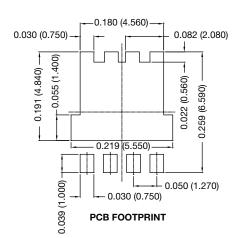
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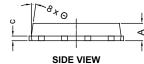
DIMENSIONS in inches (millimeters)

FlatPAK 5 x 6









DIM.		INCHES			MILLIMETERS			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.035	0.039	0.043	0.89	0.99	1.09		
(a)	-	0.006	-	-	0.15	-		
b	0.013	0.017	0.020	0.32	0.43	0.52		
b1	0.013	0.017	0.020	0.32	0.43	0.52		
С	0.008	-	0.014	0.20	-	0.35		
D	0.197	0.203	0.209	5.00	5.15	5.30		
D1	0.189	0.193	0.197	4.80	4.90	5.00		
D2	0.154	0.161	0.169	3.90	4.10	4.30		
(d1)	-	0.016	-	-	0.40	-		
(d2)	-	0.005	-	-	0.125	-		
E	0.238	0.244	0.250	6.05	6.20	6.35		
E1	0.228	0.232	0.236	5.80	5.90	6.00		
E2	0.157	0.165	0.173	4.00	4.20	4.40		
(E3)	-	0.144	-	-	3.65	-		
е		0.050 BSC			1.27 BSC			
(K)	0.039	-	-	1.00	-	-		
L1	0.019	-	0.043	0.48	-	1.10		
L2	0.012	-	0.031	0.30	-	0.80		
М	0.128	0.138	0.148	3.25	3.50	3.75		
Θ	0°	-	10°	0°	-	10°		

Notes

Dimensioning and tolerancing per ASME Y14.5-2009

• Dimensions D1 and E1 do not include mold flash or gate burrs

• Dimension (XX) means reference only

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